

Mounted SOC data sheet SOC- λ -A-T- τ -5.0-25.4g

GaAs chip area standard: 5.0 mm x 5.0 mm

optional: other dimensions on request

Chip material semi-insulating GaAs

Chip thickness standard: 625 µm

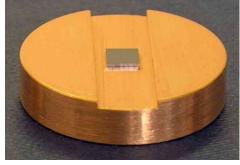
optional: 150 µm

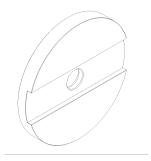
Back side polished and antireflection (AR) coated for the design wavelength λ

Front side protection the SOC is protected with a dielectric front layer

The SOC chip is glued on a gold-plated Cu-cylinder with 25.4 mm outer diameter and a 4 mm \emptyset center hole using a thermal conducting paste.







Mount: gold-plated copper cylinder with:

25.4 mm outer diameter 4 mm diameter center hole 3 mm thickness

